

# PRTR5V0U2X

Ultra low capacitance double rail-to-rail ESD protection diode

Rev. 02 — 14 January 2008 Product data sheet

## 1. Product profile

## 1.1 General description

Ultra low capacitance rail-to-rail ElectroStatic Discharge (ESD) protection diode in a small SOT143B Surface-Mounted Device (SMD) plastic package designed to protect two Hi-Speed data lines or high-frequency signal lines from the damage caused by ESD and other transients.

PRTR5V0U2X incorporates two pairs of ultra low capacitance rail-to-rail diodes as well as an additional ESD protection diode to ensure signal line protection even if no supply voltage is available.

### 1.2 Features

- ESD protection of two Hi-Speed data lines or high-frequency signal lines
- Ultra low input/output to ground capacitance: C<sub>(I/O-GND)</sub> = 1 pF
- ESD protection up to 8 kV
- IEC 61000-4-2, level 4 (ESD)
- Very low clamping voltage due to an integrated additional ESD protection diode
- Very low reverse current
- Small SMD plastic package

## 1.3 Applications

- USB 2.0 ports
- Digital Video Interface (DVI) / High Definition Multimedia Interface (HDMI) interfaces
- Mobile and cordless phones
- Personal Digital Assistants (PDA)
- Digital cameras
- Wide Area Network (WAN) / Local Area Network (LAN) systems
- PCs, notebooks, printers and other PC peripherals



## 1.4 Quick reference data

**Quick reference data** 

T<sub>amb</sub> = 25 °C unless otherwise specified.

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Symbol	Parameter	Conditions	M	lin	Тур	Max	Unit
Per diode							
$V_{RWM}$	reverse standoff voltage		-		-	5.5	V
$C_{\text{(I/O-GND)}}$	input/output to ground capacitance	f = 1 MHz; $V_{(I/O-GND)} = 0 V$	<u>[1]</u> -		1	1.5	pF
C <sub>sup</sub>	supply pin to ground capacitance	f = 1 MHz; $V_{CC} = 0 V$	[2] -		16	-	pF

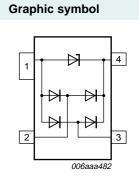
- [1] Measured from pin 2 and 3 to ground.
- [2] Measured from pin 4 to ground.

#### **Pinning information** 2.

Table 2. **Pinning** 

Pin	Symbol	Description	Simplified outline
1	GND	ground	
2	I/O 1	input/output 1	4 3
3	I/O 2	input/output 2	
4	$V_{CC}$	supply voltage	





#### **Ordering information** 3.

Table 3. **Ordering information** 

Type number	Package		
	Name	Description	Version
PRTR5V0U2X	-	plastic surface-mounted package; 4 leads	SOT143B

# **Marking**

Table 4. **Marking codes** 

Type number	Marking code <sup>[1]</sup>
PRTR5V0U2X	*R1

- [1] \* = -: made in Hong Kong
  - \* = p: made in Hong Kong
  - \* = t: made in Malaysia
  - \* = W: made in China

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# 5. Limiting values

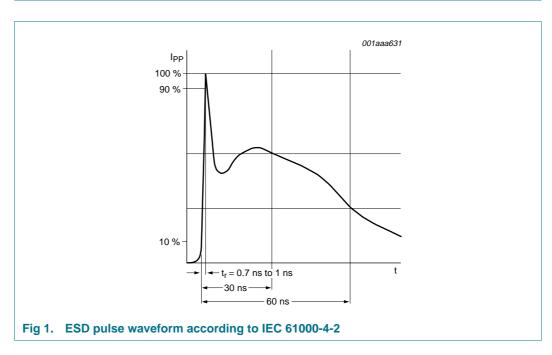
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per device					
T <sub>amb</sub>	ambient temperature		-40	+85	°C
T <sub>stg</sub>	storage temperature		-55	+125	°C

Table 6. ESD standards compliance

Standard	Conditions
Per diode	
IEC 61000-4-2; level 4 (ESD)	> 8 kV (contact)



## 6. Characteristics

Table 7. Characteristics

T<sub>amb</sub> = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
$V_{RWM}$	reverse standoff voltage		-	-	5.5	V
$I_R$	reverse current	$V_R = 3 V$	<u>[1]</u> -	< 1	100	nΑ
$V_{BR}$	breakdown voltage		<u>[2]</u> 6	-	9	V
$C_{\text{(I/O-GND)}}$	input/output to ground capacitance	f = 1 MHz; $V_{(I/O-GND)} = 0 V$	[3] _	1	1.5	pF
$C_{(I/O-I/O)}$	input/output to input/output capacitance	f = 1  MHz; $V_{(I/O-I/O)} = 0 \text{ V}$	<u>[4]</u> _	0.6	-	pF
C <sub>sup</sub>	supply pin to ground capacitance	f = 1 MHz; $V_{CC} = 0 V$	[2] _	16	-	pF
V <sub>F</sub>	forward voltage		-	0.7	-	V

- [1] Measured from pin 2, 3 and 4 to ground.
- [2] Measured from pin 4 to ground.
- [3] Measured from pin 2 and 3 to ground.
- [4] Measured from pin 2 to pin 3.

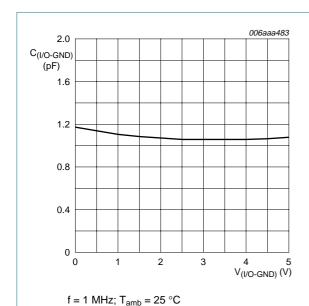
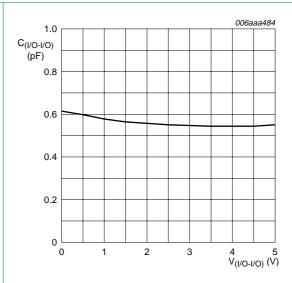
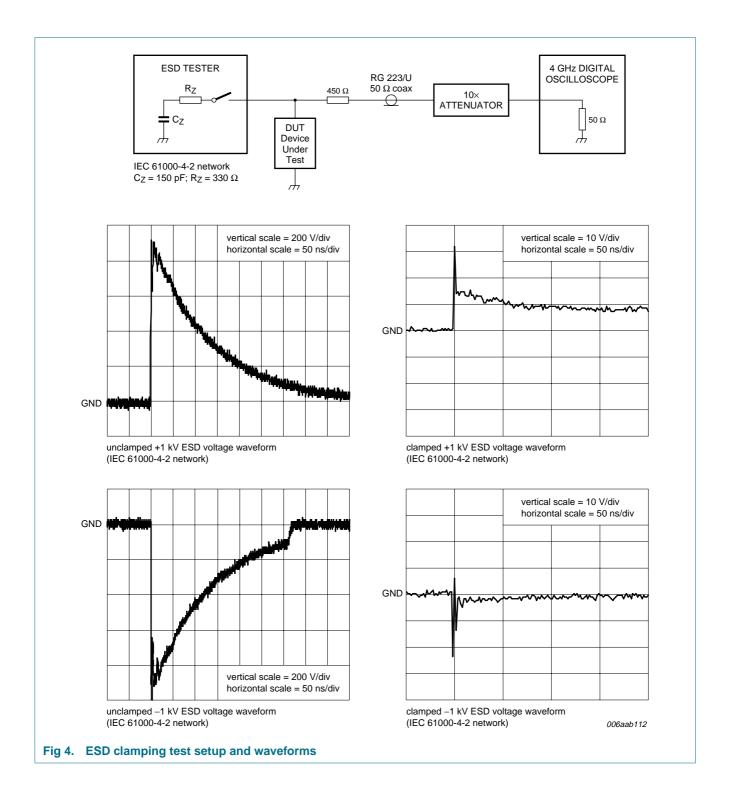


Fig 2. Input/output to ground capacitance as a function of input/output to ground voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \, ^{\circ}\text{C}$ 

Fig 3. Input/output to input/output capacitance as a function of input/output to input/output voltage; typical values



## 7. Application information

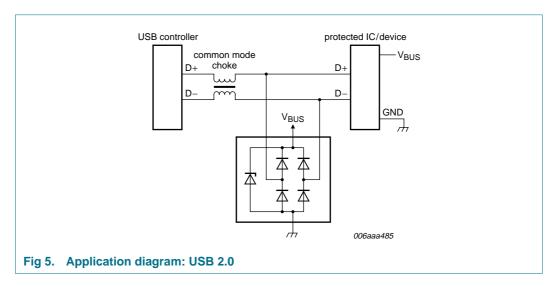
Handling data rates up to 480 Mbit/s, USB 2.0 interfaces require ESD protection devices with an extremely low line capacitance in order to avoid signal distortion.

With a capacitance of only 1 pF, the PRTR5V0U2X offers IEC 61000-4-2, level 4 compliant ESD protection.

The PRTR5V0U2X integrates two pairs of ultra low capacitance rail-to-rail ESD protection diodes and an additional ESD protection diode.

The additional ESD protection diode connected between ground and  $V_{CC}$  prevents charging of the supply.

To achieve the maximum ESD protection level, no additional external capacitors are required.



### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

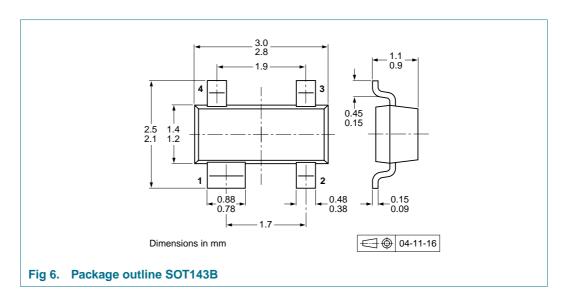
- 1. Place the PRTR5V0U2X as close to the input terminal or connector as possible.
- 2. The path length between the PRTR5V0U2X and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

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## Package outline



#### **Packing information** 9.

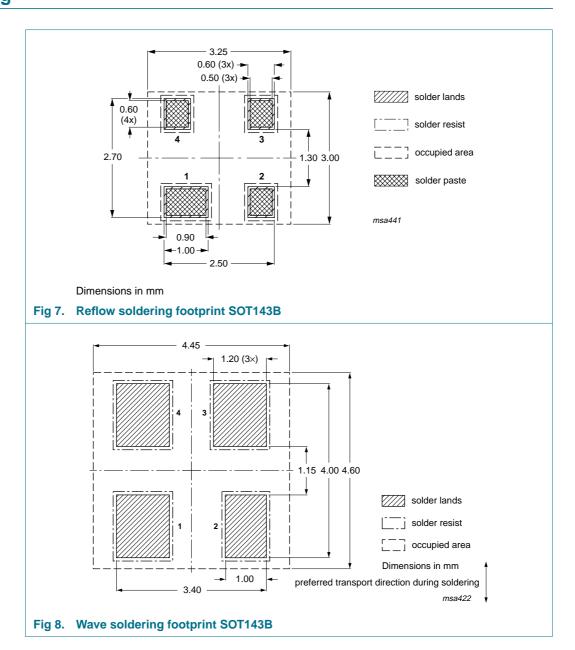
Table 8. **Packing methods** 

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description Packing quant		quantity
			3000	10000
PRTR5V0U2X	SOT143B	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see Section 13.

## 10. Soldering



# 11. Revision history

#### Table 9. **Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes		
PRTR5V0U2X_2	20080114	Product data sheet	-	PRTR5V0U2X_1		
Modifications:	cations:  • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.					
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
	<ul> <li>Table 1: parameter for C<sub>(I/O-GND)</sub> redefined to input/output to ground capacitance</li> </ul>					
	<ul> <li><u>Table 1 "Quick reference data"</u>: maximum value for C<sub>(I/O-GND)</sub> added</li> </ul>					
	<ul> <li>Table 7: parameter for C<sub>(I/O-GND)</sub> redefined to input/output to ground capacitance</li> </ul>					
	<ul> <li>Table 7 "Characteristics": maximum value for C<sub>(I/O-GND)</sub> added</li> </ul>					
	<ul> <li>Table 7: parameter for C<sub>(I/O-I/O)</sub> redefined to input/output to input/output capacitance</li> </ul>					
	<ul> <li>Table 7: parameter for C<sub>sup</sub> redefined to supply pin to ground capacitance</li> </ul>					
	Section 10 "Soldering": added					
	<ul> <li>Section 12 "Legal information": updated</li> </ul>					
PRTR5V0U2X_1	20050922	Product data sheet	-	-		

**Product data sheet** 

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## 12. Legal information

#### 12.1 **Data sheet status**

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- The term 'short data sheet' is explained in section "Definitions
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# PRTR5V0U2X

## Ultra low capacitance double rail-to-rail ESD protection diode

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